

**EAST Search History****EAST Search History (Prior Art)**

<b>Ref #</b>	<b>Hits</b>	<b>Search Query</b>	<b>DBs</b>	<b>Default Operator</b>	<b>Plurals</b>	<b>Time Stamp</b>
L1	15	(hakan near2 holmberg).in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:03
L2	15	l1 and stainless	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:03
L3	1	l1 and tolerance	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:05
L4	1	l1 and adhesion	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:07
L5	8	l1 and tensile	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:08
L6	4	l1 and ((spring or gasket) same tensile)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:10
L7	4	l1 and (electric\$6)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:13

L8	1	l1 and (connector or switch\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:16
L9	5017	stainless same ((electric\$5 or conduct or conductive or conductivity or conducting or conductivities) same (connector or switch \$4 or contact or reed or spring)) same ((coating or coated or coat or plated or plating or electroplat\$6 or electroless\$6 or deposit or deposited or deposition or PVD or CVD or sputter\$5 or layer) near10 (copper or Cu or gold or Au or Ni or nickel or molybdenum or Mo or cobalt or Co or silver or Ag or tin or Sn or tungsten or W))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:21
L10	71	stainless same ((electric\$5 or conduct or conductive or conductivity or conducting or conductivities) same (connector or switch \$4 or contact or reed or spring)) same ((coating or coated or coat or plated or plating or electroplat\$6 or electroless\$6 or deposit or deposited or deposition or PVD or CVD or sputter\$5 or layer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:22

		near10 (copper or Cu or gold or Au or Ni or nickel or molybdenum or Mo or cobalt or Co or silver or Ag or tin or Sn or tungsten or W)) same toleranc \$5				
L11	1	stainless same ((electric\$5 or conduct or conductive or conductivity or conducting or conductivities) same (connector or switch \$4 or contact or reed or spring)) same ((coating or coated or coat or plated or plating or electroplat\$6 or electroless\$6 or deposit or deposited or deposition or PVD or CVD or sputter\$5 or layer) near10 (copper or Cu or gold or Au or Ni or nickel or molybdenum or Mo or cobalt or Co or silver or Ag or tin or Sn or tungsten or W)) same (thick\$5 near2 toleranc\$5)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:26
L12	69	((electric\$5 or conduct or conductive or conductivity or conducting or conductivities) same (connector or switch \$4 or contact or reed or spring)) same ((coating or coated or coat or plated or plating or electroplat\$6 or electroless\$6 or deposit or deposited	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:28

		or deposition or PVD or CVD or sputter\$5 or layer) near10 (copper or Cu or gold or Au or Ni or nickel or molybdenum or Mo or cobalt or Co or silver or Ag or tin or Sn or tungsten or W)) same (thick\$5 near2 toleranc\$5)				
L13	98	((electric\$5 or conduct or conductive or conductivity or conducting or conductivities) same (connector or switch \$4 or contact or reed or spring)) same ((coating or coated or coat or plated or plating or electroplat\$6 or electroless\$6 or deposit or deposited or deposition or PVD or CVD or sputter\$5 or layer) near10 (copper or Cu or gold or Au or Ni or nickel or molybdenum or Mo or cobalt or Co or silver or Ag or tin or Sn or tungsten or W)) same (thick\$5 near5 toleranc\$5)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 14:28
L14	2117	((electric\$5 or conduct or conductive or conductivity or conducting or conductivities) same (connector or switch \$4 or contact or reed or spring)) same ((coating or coated or coat or plated or plating or electroplat\$6 or	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 15:27

		electroless\$6 or deposit or deposited or deposition or PVD or CVD or sputter\$5 or layer) near10 (copper or Cu or gold or Au or Ni or nickel or molybdenum or Mo or cobalt or Co or silver or Ag or tin or Sn or tungsten or W)) same (thick\$5 near5 (variation or vary or variance or varies or uneven\$4 or uniform\$6))				
L15	269	((electric\$5 or conduct or conductive or conductivity or conducting or conductivities) same (connector or switch \$4 or contact or reed or spring)) same ((deposition or PVD or CVD or sputter\$5) near10 (copper or Cu or gold or Au or Ni or nickel or molybdenum or Mo or cobalt or Co or silver or Ag or tin or Sn or tungsten or W)) same (thick\$5 near5 (variation or vary or variance or varies or uneven\$4 or uniform\$6))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 15:28

L16	170	((electric\$5 or conduct or conductive or conductivity or conducting or conductivities) same (connector or switch \$4 or contact or reed or spring)) same (((vapor or chemical) near2 (deposited or desposit or depositing or deposition) or PVD or CVD or sputter \$5) near10 (copper or Cu or gold or Au or Ni or nickel or molybdenum or Mo or cobalt or Co or silver or Ag or tin or Sn or tungsten or W)) same (thick\$5 near5 (tolerance or variation or vary or variance or varies or uneven\$4 or uniform \$6))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 15:31
L17	0	((stainless) near10 (connector or switch \$4 or contact or reed or spring or terminal)) same (((vapor or chemical) near2 (deposited or desposit or depositing or deposition)) or PVD or CVD or sputter \$5) near10 (thick\$5 near5 (tolerance or variation or vary or variance or varies or uneven\$4 or uniform \$6)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 15:40

L18	302	((stainless) near10 (connector or switch \$4 or contact or reed or spring or terminal)) same (((vapor or chemical) near2 (deposited or desposit or depositing or deposition)) or PVD or CVD or sputter \$5)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 15:41
L19	103	((stainless) near10 (connector or switch \$4 or contact or reed or spring or terminal)) same (((vapor or chemical) near2 (deposited or desposit or depositing or deposition)) or PVD or CVD or sputter \$5) same (oxide or oxidation or passive or passivation or etch or etch or etched or stripped or stripping or clean or cleaned or cleaning)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 15:46
L20	4369	(stainless) same (((vapor or chemical) near2 (deposited or desposit or depositing or deposition)) or PVD or CVD or sputter \$5) same (oxide or oxidation or passive or passivation or etch or etch or etched or stripped or stripping or clean or cleaned or cleaning)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 16:07

L21	838	((stainless) near2 (strip or sheet or substrate or plate)) same (((vapor or chemical) near2 (deposited or desposit or depositing or deposition)) or PVD or CVD or sputter \$5) same (oxide or oxidation or passive or passivation or etch or etch or etched or stripped or stripping or clean or cleaned or cleaning)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 16:08
L22	105	(connector or switch \$4 or contact or reed or spring or terminal) same (((stainless) near2 (strip or sheet or substrate or plate)) same (((vapor or chemical) near2 (deposited or desposit or depositing or deposition)) or PVD or CVD or sputter \$5) same (oxide or oxidation or passive or passivation or etch or etch or etched or stripped or stripping or clean or cleaned or cleaning))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/04 16:09

**EAST Search History (Interference)**

&lt;This search history is empty&gt;

**3/4/10 4:42:10 PM****C:\Documents and Settings\JZimmerman\My Documents\EAST\Workspaces\default1.wsp**